

	L #	Hits	Search Text	DBs
1	L17	2482	(PLANARIZATI N OR PLANARIZ\$3 OR PLANAR).ti.	USPAT
2	L19	2064	(PLANARIZATI N OR PLANARIZ\$3 OR PLANAR) AND (polish\$3 or CMP).ti,ab.	USPAT
3	L21	725	((CMP OR POLISH\$3) AND (PLANARIZATION OR PLANARIZ\$3 OR PLANAR)).ti,ab.	USPAT
4	L23	34	21 and damascene	USPAT
5	L27	156	((CMP OR POLISH\$3) AND (PLANARIZATION OR PLANARIZ\$3 OR PLANAR) and (metal or copper or aluminum)).TI,AB.	USPAT
6	L29	156	((CMP OR POLISH\$3) AND (PLANARIZATION OR PLANARIZ\$3 OR PLANAR) AND (COPPER OR ALUMINUM OR METAL)).TI,AB.	USPAT
7	L33	84	((CMP OR POLISH\$3) AND ((PLANARIZATION OR PLANARIZ\$3 OR PLANAR) with (COPPER OR ALUMINUM OR METAL))).TI,AB.	USPAT
8	L37	2	before with remov\$3 with (higher or elevated) with (planarization or planariz\$3)	USPAT
9	L41	1	((((PLANARIZATION OR PLANARIZ\$3) WITH BEFORE) WITH (high) WITH REMOV\$3)	USPAT
10	L43	0	((((PLANARIZATION OR PLANARIZ\$3) WITH BEFORE) WITH (ELEVATED OR high or HIGHER) WITH REMOV\$3)	EPO; JPO

5/11/00 EK